

I078 0093 TWB/cd

Paper No.:

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

Inventor:

WILEY, Patrick Carl

Title:

METHOD OF FORMING AN INLAID PATTERN IN AN ASPHALT

SURFACE

Serial No.:

10/000,448

Filed:

4 December 2001

Date:

18 June 2002

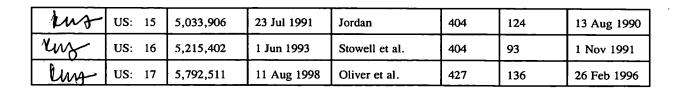
Commissioner for Patents Washington, D.C. 20231

Dear Sir:

LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT [Form PTO-1449 (Modified)]

United States Patent Documents

Examiner	ID	Patent No.	Issue Date	Inventor(s)	Class	Sub-Cl	Filing Date
sus	US: 1	1,950,169	6 Mar 1934	J. Farasey	94	1.5	23 Jan 1931
w	US: 2	5,560,734	1 Oct 1996	McIntosh et al.	404	15	27 Aug 1993
Kurt	US: 3	6,213,680	10 Apr 2001	Schaeffer et al.	404	92	30 Apr 1999
Kmt	US: 4	5,421,670	6 Jun 1995	Meirick	404	124	9 May 1994
leur	US: 5	5,133,621	28 Jul 1992	Gonzales	404	72	25 Apr 1991
my	US: 6	2,866,992	6 Jan 1959	H.A. Toulmin, Jr.	15	131.05	15 Oct 1954
king	US: 7	5,494,372	27 Feb 1996	Oliver et al.	404	72	3 May 1994
ema	US: 8	5,447,752	5 Sep 1995	Cobb	427	270	9 Jun 1994
KM	US: 9	5,487,526	30 Jan 1996	Hupp	249	2	6 May 1994
kmy	US: 10	6,024,511	15 Feb 2000	Ross	404	93	5 Jun 1998
Kma	US: 11	1,063,752	3 Jun 1913	W.F. Walling			25 Oct 1911
kny.	US: 12	3,832,079	27 Aug 1974	Moorhead	404	72	10 Aug 1972
ems	US: 13	3,874,806	1 Apr 1975	Grist et al.	404	93	27 Jul 1972
ikmy	US: 14	4,105,354	8 Aug 1978	Bowman	404	72	27 Apr 1977



Foreign Patent Documents

Examiner	ID	Publn. No.	Publn. Date	Country/Inventor	Class	Sub-Cl	Translation?
ous	FP : 1	WO 87/02724	7 May 1987	Australia/Walden	9	08	
kma	FP: 2	29 18 860	20 Nov 1980	Germany/Sudbrack	11	24	Yes*

*Abstract only

Other Art

Examiner	ID	Author, Title, Date, Pertinent Pages, etc.		
	OA: 1	Cataphote, Cata-Groove Snow Plow Resistant Thermoplastic Marking Material, Pags 1-5,		
lour		dated July 1998		

Examiner:

Date Considered:

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not

considered. Include copy of this form with next communication to

applicant.